CMOS 4-Bit Microcontroller

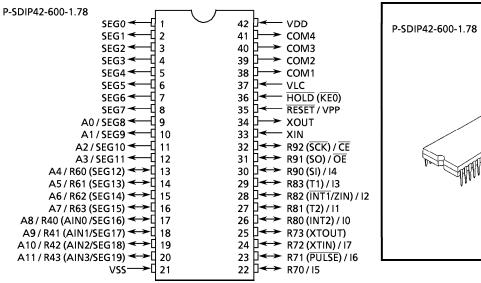
TMP47P422VN TMP47P422VF **TMP47P422VU**

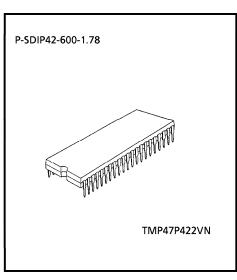
The TMP47P422V is the system evaluation LSI of TMP47C222/422 with a 32 Kbit one-time PROM. The TMP47P422V programs / verifies using an adapter socket to connect with PROM programmer, as it is in

In addition, the TMP47P422V and the TMP47C222/422 are pin compatible. The TMP47P422V operates as the same as the TMP47C222/422 by programming to the internal PROM.

Part No.	EPROM	RAM	Package	Adapter Socket
TMP47P422VN	OTP		P-SDIP42-600-1.78	BM11102
TMP47P422VF		256 × 4-bit	P-QFP44-1414-0.80D	BM11103
TMP47P422VU	4096 × 8-bit		P-QFP44-1010-0.80	BM11170

Pin Assignment (Top View)





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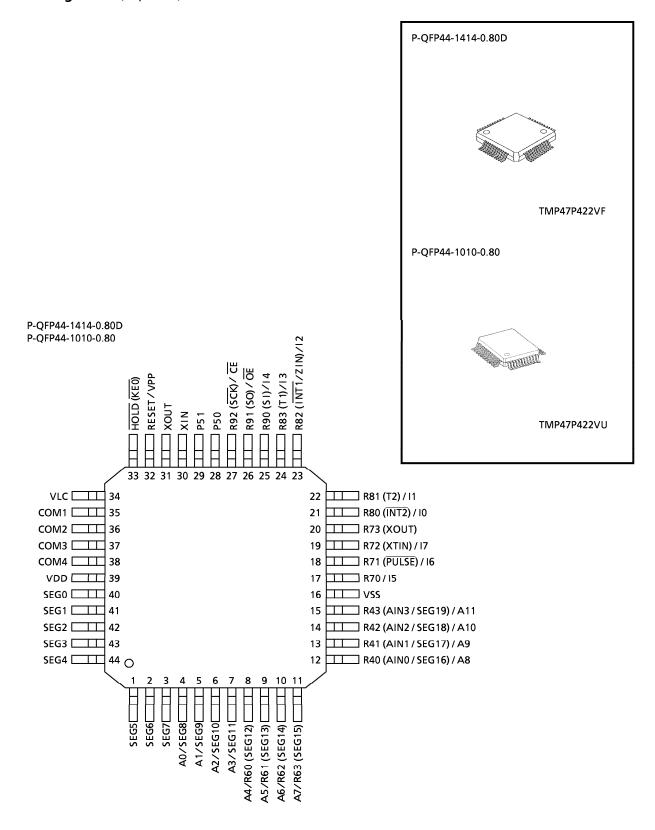
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Pin Assignment (Top View)



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Pin Function

The TMP47P422V has MCU mode and PROM mode.

(1) MCU mode The TMP47C222/422 and the TMP47P422V are pin compatible.

(2) PROM mode

Pin Name	Input / Output	Functions	Pin Nam	ne (MCI	J mode)	
A11 to A8			R43	to	R40	
A7 to A4	Input	Address inputs	R63	to	R60	
A3 to A0			SEG11	to	SEG8	
17 to 15			R72	to	R70	
14	I/O	Data inputs / outputs				
13 to 10			R83	to	R80	
CE		Chip Enable input	R92			
ŌĒ	Input	Output Enable input	R91			
VPP		+ 12.5 V / 5 V (Program supply voltage)	RESET			
vcc	Power supply	+5V	VDD			
VSS		ov	VSS			
HOLD	Input	PROM mode setting pin. Be fixed to low level.				
XIN	Input	Input the clock from the external oscillator. (8 MHz typ.)				
XOUT	Input	Be pulled down to VSS level. (750 Ω typ.)				
SEG7 to SEG0	•					
COM4 to COM0	Output	Open				
VLC	Power supply	Be fixed to VSS level.				

Operational Description

The following is an explanation of hardware configuration and operation in relation to the TMP47P422V. The TMP47P422V is the same as the TMP47C222/422 except that an OTP is used instead of a built-in mask ROM.

1. Operation mode

The TMP47P422V has a MCU mode and a PROM mode.

1.1 MCU mode

The MCU mode is set by attaching a resonator between the XIN and Xout pins. Operation in the MCU mode is the same as for the TMP47C222/422. In the TMP47P422V, RC oscillation is impossible.

1.1.1 Program Memory

The program storage area is the same as for the TMP47C422.

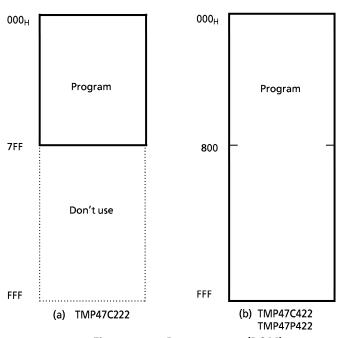


Figure 1-1. Program area (ROM)

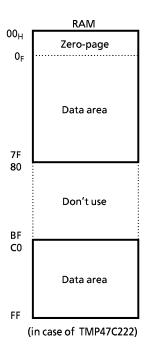


Figure 1-2. RAM addressing

1.1.2 Data Memory

The TMP47P422V contains 256×4 -bit (equivalent to TMP47C422) data memory. When the TMP47P422V is used as evaluator of the TMP47C222, programming should be performed assuming that the RAM is assigned to addresses 00 to 7F_H and C0 to FF_H as show in Figure 1-2 by considering the application software evaluation. When the BM47C422 (emulator) is used as the TMP47C222 evaluator, it is sam.

1.1.3 Input / Output Circuitry

(1) Control pins

TMP47P422V is the same as code SA of the TMP47C222/422. In the TMP47P422V, RC oscillation is impossible. Connecting the resonator or inputting the external clock to XIN pin are required when using as evaluator of I/O code SD.

(2) I/O Ports

The input / output circuit of the TMP47P422V is the same as the TMP47C222/422.

Electrical Characteristics

Absolute Maximum Ratings $(V_{SS} = 0 V)$

Parameter	Symbol	Pins	Ratings	Unit	
Supply Voltage	V_{DD}		– 0.3 to 6.5	V	
Program Voltage	V_{PP}	RESET / VPP pin	- 0.3 + 13.0	٧	
Input Voltage	V_{IN}		-0.3 to $V_{DD} + 0.3$	٧	
Output Voltage	V _{OUT}		-0.3 to $V_{DD} + 0.3$	٧	
(Par 4 six)	I _{OUT1}	Port R4, R7	30		
Output Current (Per 1 pin)	I _{OUT2}	Port R5, R6, R8, R9	120	mA	
Output Current	ZI _{OUT}	Port R4, R7	120	mA	
Power Dissipation [Topr = 70°C]	PD		400	mW	
Soldering Temperature (time)	Tsld		260 (10 s)	°C	
Storage Temperature	Tstg		– 55 to 125	°C	
Operating Temperature	Topr		– 30 to 70	°C	

Note: The absolute maximum ratings are rated values which must not be exceeded during operation, even for an instant.

Any one of the ratings must not be exceeded. If any absolute maximum rating is exceeded, a device may break down or its performance may be degraded, causing it to catch fire or explode resulting in injury to the user. Thus, when designing products which include this device, ensure that no absolute maximum rating value will ever be exceeded.

Recommended Operating Conditions

 $(V_{SS} = 0 \text{ V}, \text{ Topr} = -30 \text{ to } 70^{\circ}\text{C})$

Parameter	Symbol	Pins	Conditions	Min	Max	Unit
			fc = 8.0 MHz	2.7		
Cumplu Valtage	\ ,,		fc = 4.2 MHz	2.2		_v
Supply Voltage	V_{DD}		In the SLOW mode	2.2	5.5	'
			In the HOLD mode	2.0		
	V_{IH1}	Except Hysteresis Input	In the normal	$V_{DD} \times 0.7$		
Input High Voltage	V_{IH2}	Hysteresis Input	operating area	$V_{DD} \times 0.75$	V _{DD}	V
	V _{IH3}		In the HOLD mode	$V_{DD} \times 0.9$		
	V_{IL1}	Except Hysteresis Input	In the normal		$V_{DD} \times 0.3$	
Input Low Voltage	V_{IL2}	Hysteresis Input	operating area	0	$V_{DD} \times 0.25$	v
	V _{IL3}		In the HOLD mode		$V_{DD} \times 0.1$	
	fc	VIN VOLIT	$V_{DD} = 2.7 \text{ to } 5.5 \text{ V}$	0.4	8.0	MHz
Clock Frequency	тс	XIN, XOUT	$V_{DD} = 2.2 \text{ to } 5.5 \text{ V}$	0.4	4.2	IVITIZ
	fs	XTIN, XTOUT	$V_{DD} = 2.2 \text{ to } 5.5 \text{ V}$	30	34	kHz

Note: The recommended operating conditions for a device are operating conditions under which it can be guaranteed that the device will operate as specified. If the device is used under operating conditions other than the recommended operating conditions (supply voltage, operating temperature range, specified AC/DC values etc.), malfunction may occur. Thus, when designing products which include this device, ensure that the recommended operating conditions for the device are always adhered to.

DC Characteristics

 $(V_{SS} = 0 \text{ V}, \text{ Topr} = -30 \text{ to } 70^{\circ}\text{C})$

Parameter	Symbol	Pins	Conditions	Min	Тур.	Max	Unit
Hysteresis Voltage	V _{HS}	Hysteresis Input		_	0.7	_	V
la aut Commant	I _{IN1}	RESET, HOLD	V 55VV 55V/0V			± 2	
Input Current	I _{IN2}	Open drain output ports	$V_{DD} = 5.5 \text{ V}, V_{IN} = 5.5 \text{ V} / 0 \text{ V}$	_	_	±Ζ	μA
Input Resistance	R _{IN}	RESET		100	220	450	kΩ
Output Leakage Current	I _{LO}	Open drain output ports	V _{DD} = 5.5 V, V _{OUT} = 5.5 V	_	_	2	μΑ
Output Low Current	I _{OL2}	Port R4, R7	$V_{DD} = 4.5 \text{ V}, \ V_{OL} = 1.0 \text{ V}$	7	10	_	mA
Output Low	.,	Dart D4 D5 D5 D7 D0 D0	V _{DD} = 4.5 V, I _{OL} = 1.6 mA	_	-	0.4	v
Voltage	V _{OL}	Port R4, P5, R6, R7, R8, R9	$V_{DD} = 2.2 \text{ V}, \ I_{OL} = 20 \ \mu\text{A}$	-	_	0.1	\ \
Segment Output Low Registance	R _{OS1}	SEG pin			10		
Common Output Low Registance	R _{OC1}	COM pin			or 20	_	kΩ
Segment Output High Resistance	R _{OS2}	SEG pin			70		
Common Output High Resistance	R _{OC2}	COM pin	$V_{DD} = 5 \text{ V}, V_{DD} - V_{LC} = 3 \text{ V}$	-	or 200	_	kΩ
	V _{O2/3}			3.8	4.0	4.2	
Segment/Common Output Registance	V _{O1/2}	SEG / COM pin		3.3	3.5	3.7	v
	V _{O1/3}			2.8	3.0	3.2	
			V _{DD} = 5.5 V, fc = 4 MHz	_	2	4	
Supply Current (in the Normal mode)	I _{DD}		$V_{DD} = 3.0 \text{ V}, \text{ fc} = 4 \text{ MHz}$	_	1	2	mA
			$V_{DD} = 3.0 \text{ V}, \text{ fc} = 400 \text{ kHz}$	_	0.5	1	
Supply Current (in the SLOW mode)	I _{DDS}		V _{DD} = 3.0 V, fs = 32.768 kHz	-	20	40	μΑ
Supply Current (in the HOLD mode)	I _{DDH}		V _{DD} = 5.5 V		0.5	10	μΑ

- Note 1: Typ. values show those at Topr = 25° C, $V_{DD} = 5$ V.
- Note 2: Input Current I_{IN1} : The current through resistor is not included.
- Note 3: Output Resistance R_{os} , R_{oc} ; Shows on-resistance at the level switching.
- Note 4: $V_{O2/3}$; Shows 2/3 level output voltage, when the 1/4 or 1/3 duty LCD is used.
 - $V_{O1/2}$; Shows 1/2 level output voltage, when the 1/2 duty or static LCD is used.
 - $V_{O1/3}$; Shows 1/3 level output voltage, when the 1/4 or 1/3 duty LCD is used.
- Note 5: Supply Current I_{DD} , I_{DDH} : $V_{IN} = 5.3 \text{ V} / 0.2 \text{ V} (V_{DD} = 5.5 \text{ V})$, 2.8 V / 0.2 V ($V_{DD} = 3.0 \text{ V}$)
 - Supply Current I_{DDS} ; $V_{IN} = 2.8 \text{ V} / 0.2 \text{ V}$. Low frequency clock is only osillated.
- Note 6: When using LCD, it is necessary to consider values of Ros 1/2 and Roc 1/2.
- Note 7: Times fou SEG/COM output switching on; Ros1, Roc1: 2/fc (s)

Ros2, Roc2: $1/(n \cdot f_F)$ (1/n; duty, f_F : frame frequency)

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AD Conversion Characteristics

 $(Topr = -30 \text{ to } 70^{\circ}C)$

Parameter	Symbol	Conditions	Min	Тур.	Max	Unit
Analog Reference Voltage Range	ΔV _{AREF}	V _{DD} - V _{SS}	2.7	_	_	V
Analog Input Voltage	V _{AIN}		V _{SS}	_	V _{DD}	٧
Analog Supply current	I _{REF}		_	0.5	1.0	mA
Nonlinearity Error			_	_	± 1	
Zero Point Error		V _{DD} = 2.7 V to 5.5 V	_	_	± 1	
Full Scale Error		V _{SS} = ± 0.000 V	_	_	± 1	LSB
Total Error			_	_	± 2	

AC	Characteristics
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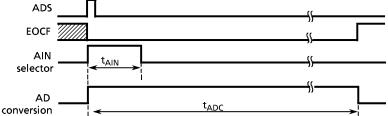
 $(V_{SS} = 0 \text{ V}, \text{ Topr} = -30 \text{ to } 70^{\circ}\text{C})$

Parameter	Symbol	Con	ditions	Min	Тур.	Max	Unit
		In the normal	$V_{DD} = 2.7 \text{ to } 5.5 \text{ V}$	1.0			
Instruction Cycle Time	tcy	mode	V _{DD} = 2.2 to 5.5 V	1.9	_	20	μ s
		In the S	LOW mode	235		267	
High level clock pulse width			V _{DD} ≧ 2.7 V	60			
	t _{WCH}	For external	V _{DD} <2.7 V	120		_	
	t _{WCL}	clock (XIN input)	V _{DD} ≧ 2.7 V	60	_		ns
Low level clock pulse width			V _{DD} <2.7 V	120			
AD Conversion Time	t _{ADC}			-	24 tcy	ı	
AD Sampling Time	t _{AIN}			-	2 tcy	1	μ s
Shift data Hold Time	t _{SDH}			0.5 tcy – 0.3	_	_	μs

Note 1: AD conversion timing: Internal circuit for pins AIN0 to 7

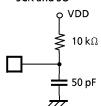
Comp. (Hi-Z) 12 pF 5 kΩ (typ.)

Electrical change inust be loaded into the buit-in condensen during t_{AIN} for normal AD conversion. AD conversion timing

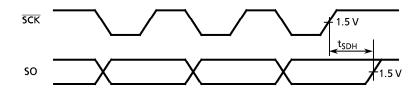


Note2: Shift data Hold Time: External circuit for pins

SCK and SO



Serial port (completed of transmission)



Zero-Cross Detection Characteristics

$$(V_{SS} = 0 \text{ V}, \text{ Topr } = -30 \text{ to } 70 ^{\circ}\text{C})$$

Characteristics are equivalent to the TMP47C222/422's.

Recommended Oscillating Conditions

$$(V_{SS} = 0 \text{ V}, V_{DD} = 2.2 \text{ to } 5.5 \text{ V}, \text{ Topr} = -30 \text{ to } 70^{\circ}\text{C})$$

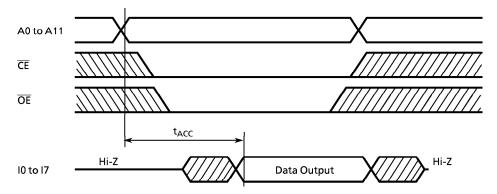
Recommended oscillating conditions of the TMP47P422V are equal to the TMP47C222/422's but RC oscillation is impossible.

DC/AC Characteristics

 $(V_{SS} = 0 V)$

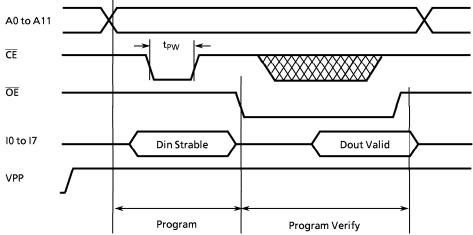
(1) Read Operation

Parameter	Symbol	Condition	Min	Тур.	Max	Unit
Output Level High Voltage	V _{IH4}		V _{CC} × 0.7	-	V _{CC}	٧
Output Level Low Voltage	V _{IL4}		0	-	V _{CC} × 0.3	V
Supply Voltage	V _{CC}		4.75		6.0	\ \
Programming Voltage	V_{PP}		4.75	_	6.0	v
Address Access Time	t _{ACC}	V _{CC} = 5.0 ± 0.25 V	0	_	350	ns



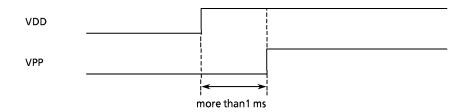
(2) High Speed Programming Operation

Parameter	Symbol	Condition	Min	Тур.	Max	Unit
Input High Voltage	V _{IH4}		V _{CC} × 0.7	-	V _{CC}	٧
Input Low Voltage	V _{IL4}		0	-	V _{CC} × 0.3	V
Supply Voltage	V _{CC}		4.75	-	6.0	٧
V _{PP} Power Supply Voltage	V _{PP}		12.00	12.50	13.00	٧
Programming Pulse Width	t _{PW}	V _{CC} = 6.0 ± 0.25 V	0.95	1.0	1.05	ms



Note: There are some PROM programmer types which cannot program OTP.

In TMP47P422V, VPP pin is also used as RESET pin. To set a mode, REST/VPP pin must be set to "low" during 1 ms and more after the rising of power-on and the rising of VDD electrical power.



Recommended EPROM programmer

TYPE

R4945 (ADVANTEST) UNISITE (DATA I/O) AF – 9706 (ANDO)

PECKER - 11 (AVAL DATA)